



FIG. 1A

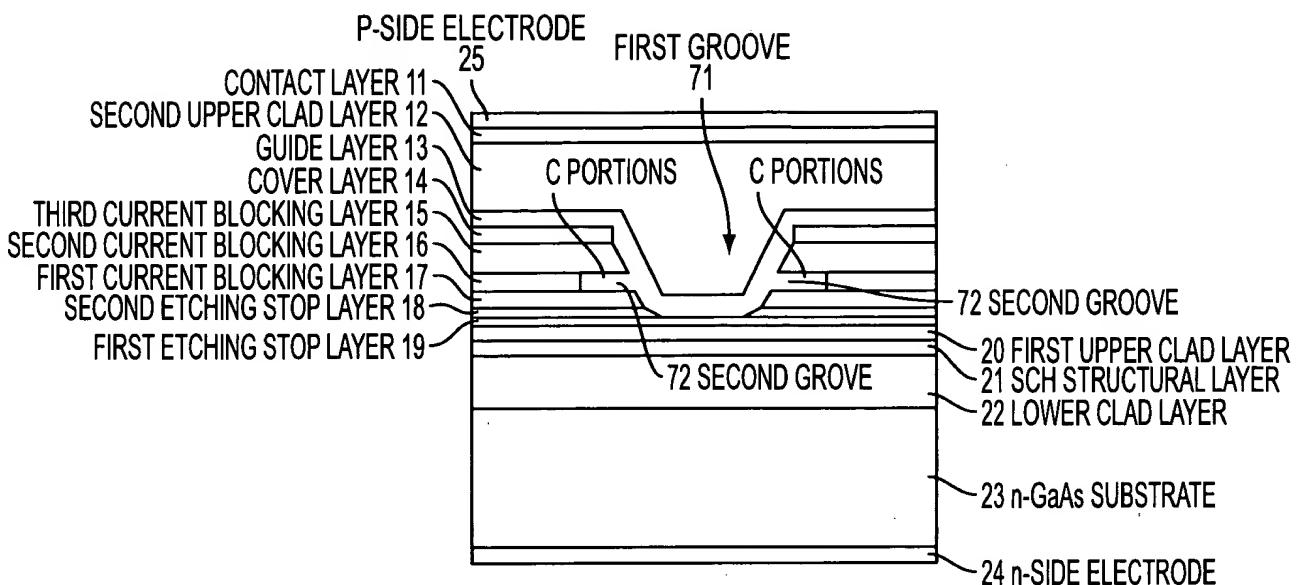


FIG. 1B

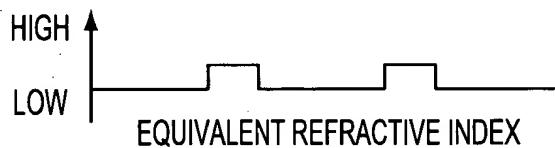
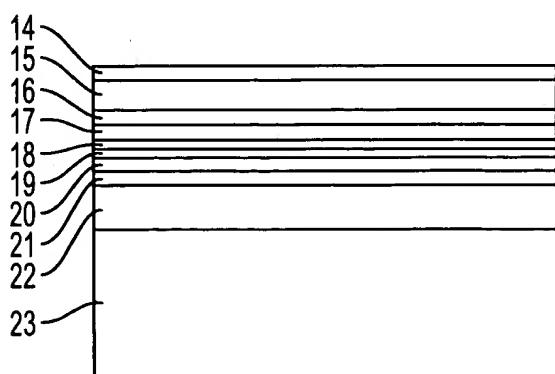


FIG. 2



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FIG. 7A

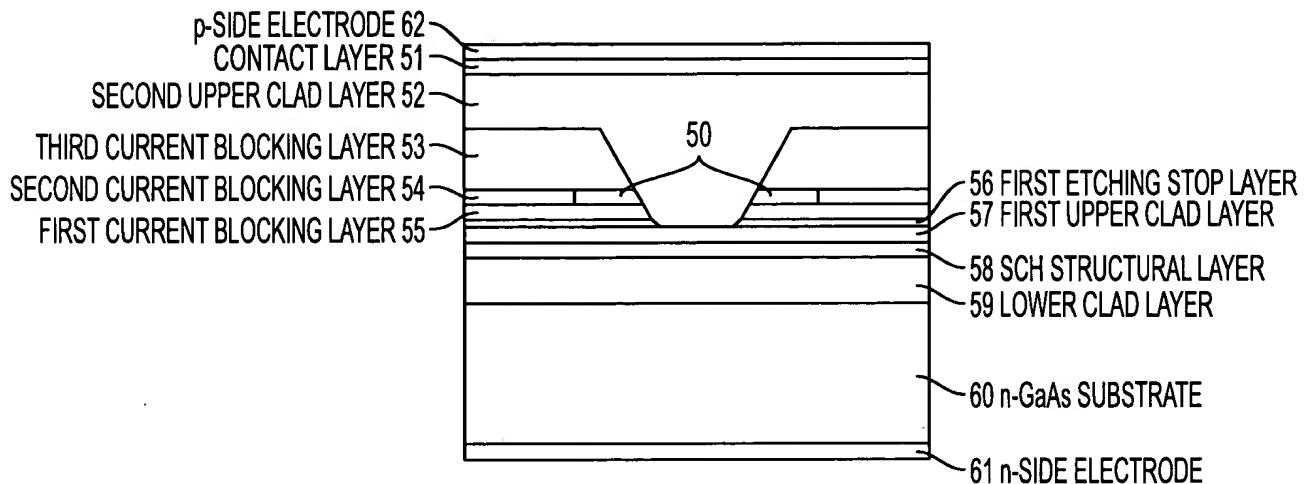


FIG. 7B

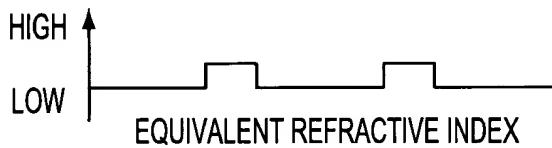


FIG. 8

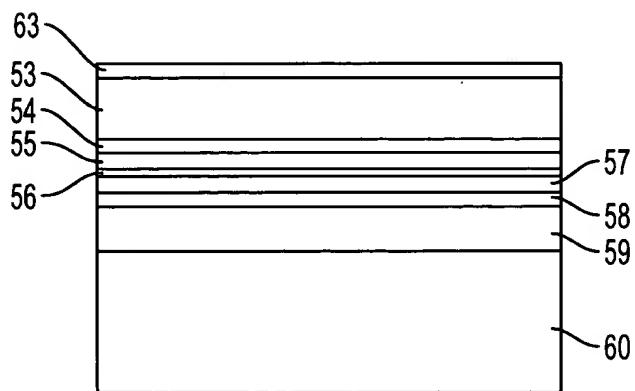




FIG. 12

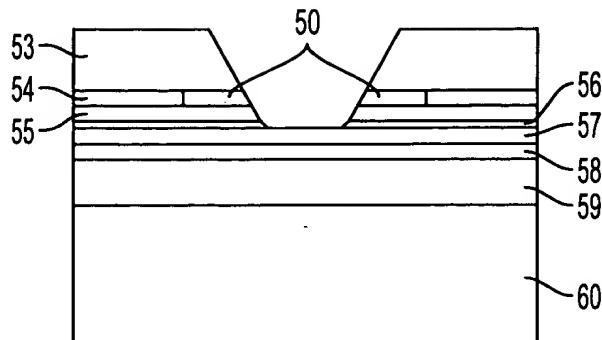


FIG. 13A

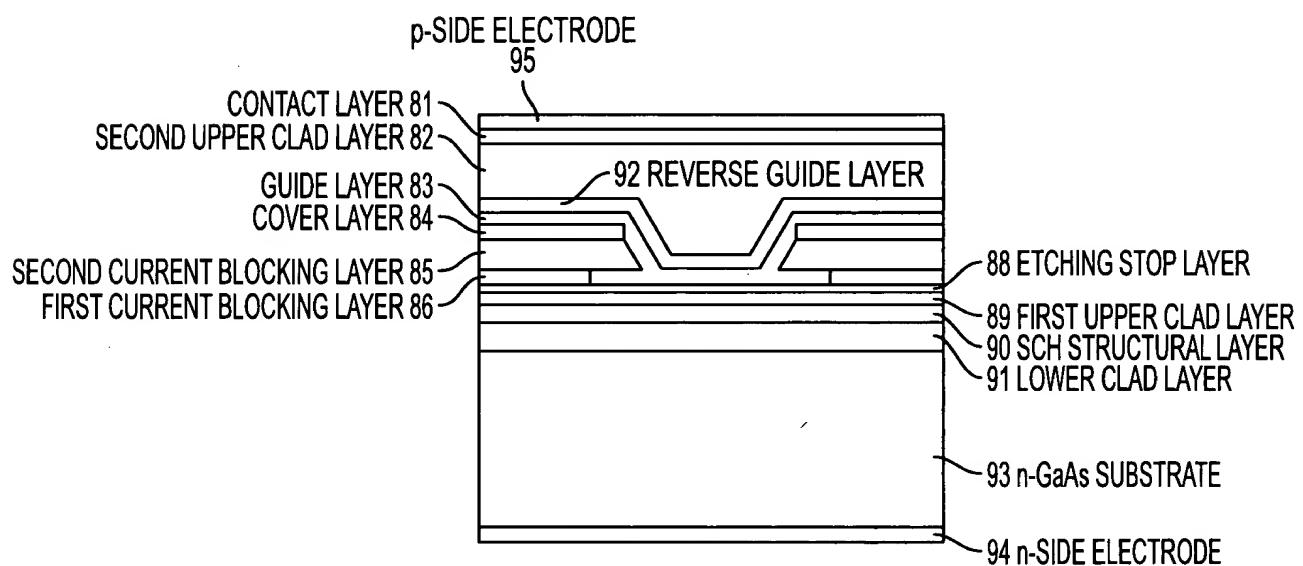
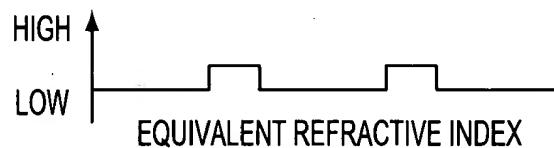
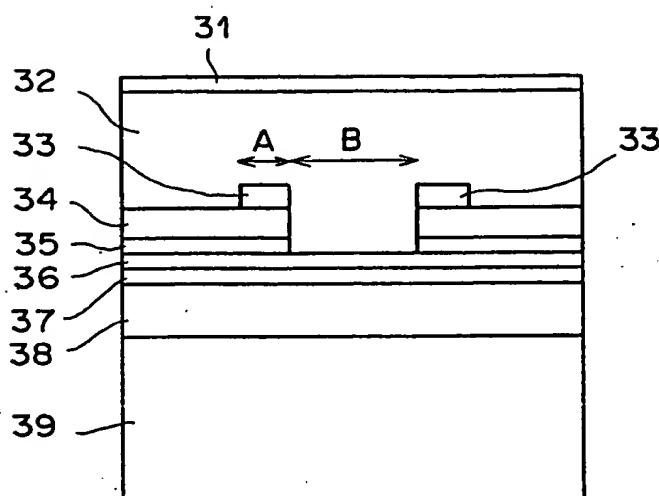


FIG. 13B



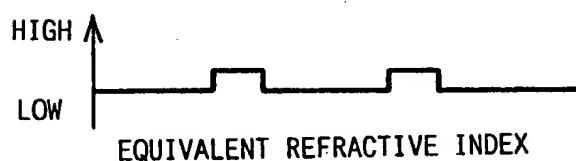


F I G . 18A



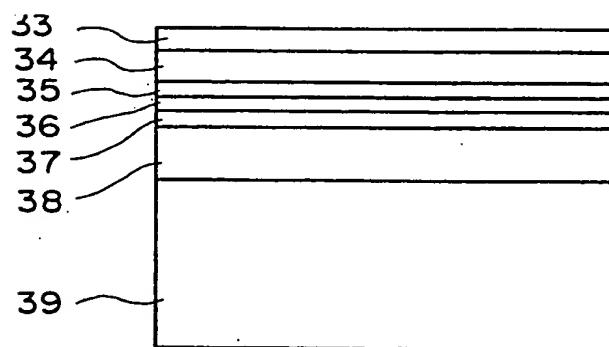
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F I G . 18B



PRIOR ART

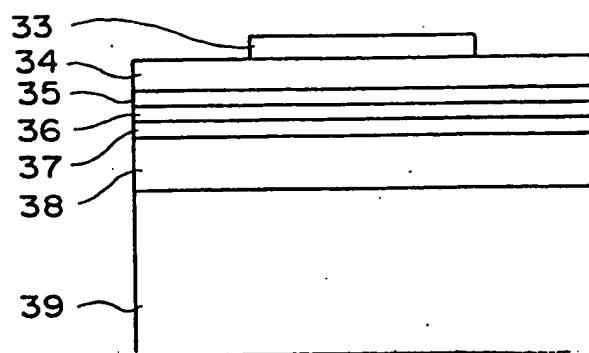
F I G . 19



PRIOR ART

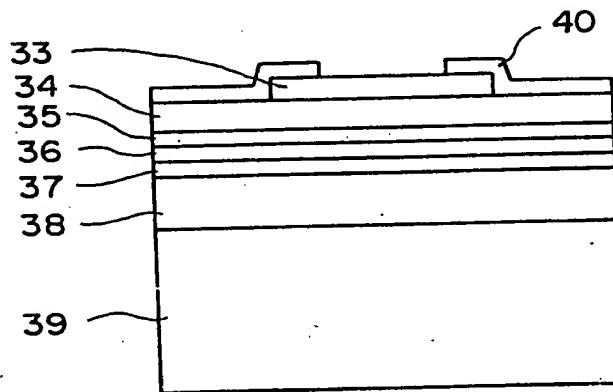


F I G . 20



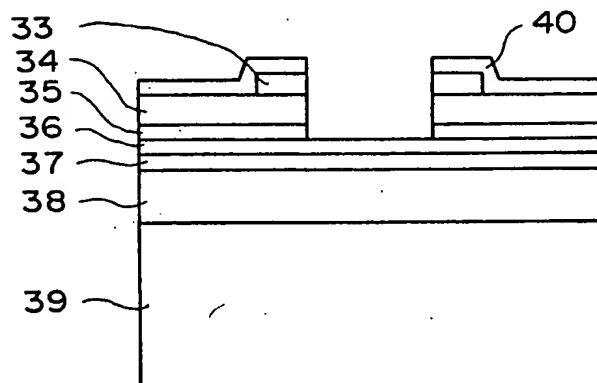
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F I G . 21



PRIOR ART

F I G . 22



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